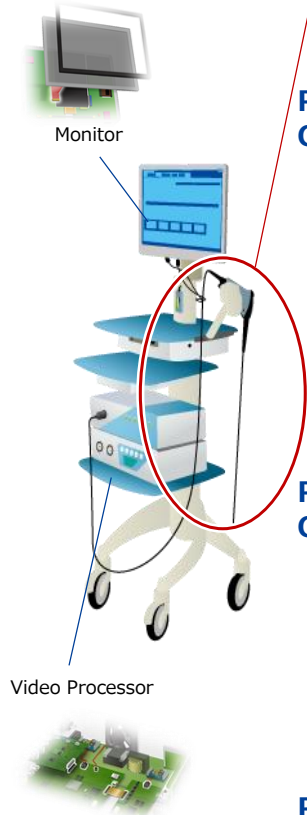


Interconnect Solutions for Endoscope

Endoscopic System

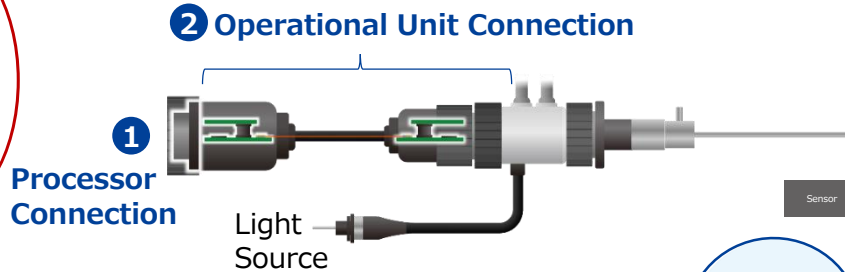


Endoscope

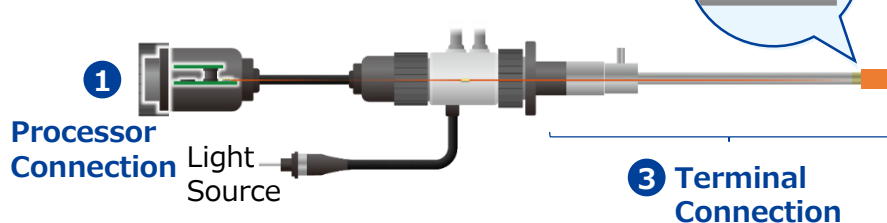
Flexible Endoscope



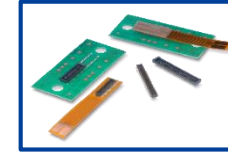
Rigid Endoscope (Thinner Type)



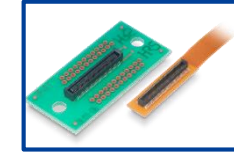
Rigid Endoscope (Thicker Type)



1 2 Board-to-Board for Processor/Operational Unit Connection



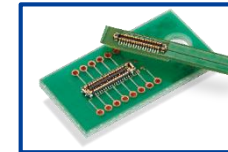
DF40
Pitch : 0.4mm
Stacking Height : 1.5-4.0mm
No. of Pos. : 10-120



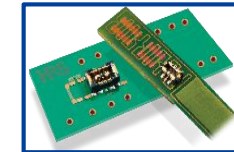
DF40T
High Heat Resistance
Pitch : 0.4mm
Stacking Height : 1.5-4.0mm
No. of Pos. : 10-50
Wide Variations



BM46 HR5 5G
Pitch : 0.35mm
Depth : 2.0mm
Stacking Height : 0.6mm
No. of Pos. : 12

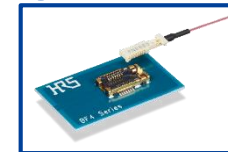


BM28
Pitch : 0.35mm
Depth : 1.7mm
Stacking Height : 0.6mm
No. of Pos. : 6-60



BM29
Pitch : 0.35mm
Depth : 1.5mm
Stacking Height : 0.6mm
No. of Pos. : 2 (Power)
2-24 (Signal)

3 Terminal Connection



BF4M
-Ultra-small Optical Transmission Module
-0.5-6.25Gbps
-High Speed Transmission
-EMI Protection



UJ
-ø0.8mm Micro Ferrule
-Compact for Narrow Spaces
-Easy and Secure Bayonet Lock
-Ferrule can be passed through ø1.6mm tube before assembling